FAIRCHILD SEMICONDUCTOR®

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FJY4002R
PNP Epitaxial Silicon Transistor with Bias Resistor

Features

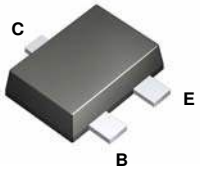
- 100 mA Output Current Capability
- Built-in Bias Resistor (R_1 = 10 kΩ, R_2 = 10 kΩ)

Application

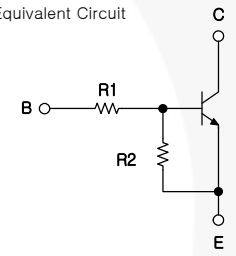
- Switching, Interface, and Driver Circuits
- Inverters
- Digital Applications in Industrial Segments

Description

Transistors with built-in resistors can be excellent space- and cost-saving solutions by reducing component count and simplifying circuit design.



SOT - 523F



Ordering Information

Part Number	Top Mark	Package	Packing Method
FJY4002R	S52	SOT-523F 3L	Tape and Reel

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only. Values are at T_A = 25°C unless otherwise noted.

Symbol	Parameter	Value	Unit
V_{CBO}	Collector-Base Voltage	-50	V
V_{CEO}	Collector-Emitter Voltage	-50	V
V_{EBO}	Emitter-Base Voltage	-10	V
I_C	Collector Current	-100	mA
T_J	Junction Temperature	150	°C
T_{STG}	Storage Temperature Range	-55 to 150	°C

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Thermal Characteristics[1]

Values are at T_A = 25°C unless otherwise noted.

Symbol	Parameter	Value	Unit
P_D	Power Dissipation	200	mW
	Derate Above T_A = 25°C	1.60	mW/°C
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	625	°C/W

Note:

1. PCB size: FR-4 76 x 114 x 0.6T mm^3 (3.0 inch x 4.5 inch x 0.062 inch) with minimum land pattern size.

Electrical Characteristics[2]

Values are at T_C = 25°C unless otherwise noted.

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$V_{(BR)CBO}$	Collector-Emitter Breakdown Voltage	I_C = -10 μA, I_E = 0	-50			V
$V_{(BR)CEO}$	Collector-Base Breakdown Voltage	I_C = -100 μA, I_B = 0	-50			V
I_{CBO}	Collector Cut-Off Current	V_{CB} = -40 V, I_E = 0			-0.1	μA
h_{FE}	DC Current Gain	V_{CE} = -5 V, I_C = -5 mA	30			
V_{CE}(sat)	Collector-Emitter Saturation Voltage	I_C = -10 mA, I_B = -0.5 mA			-0.3	V
f_T	Current Gain Bandwidth Product	V_{CE} = -10 V, I_C = -5 mA		200		MHz
C_{cb}	Output Capacitance	V_{CB} = -10 V, I_E = 0, f = 1.0 MHz		5.5		pF
V_I(off)	Input-Off Voltage	V_{CE} = -5 V, I_C = -100 μA			-0.5	V
V_I(on)	Input-On Voltage	V_{CE} = -0.3 V, I_C = -10 mA	-3			V
R_1	Input Resistor		7	10	13	kΩ
R_1/R_2	Resistor Ratio		0.9	1.0	1.1	

Note:

2. Pulse test: pulse width ≤ 300 μs, duty cycle ≤ 2%.

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Typical Performance Characteristics

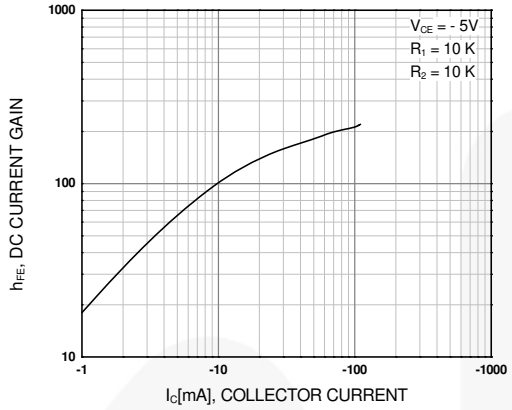

Figure 1. DC Current Gain

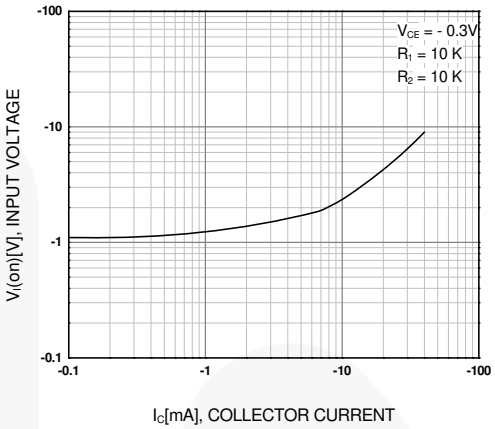

Figure 2. Input-On Voltage

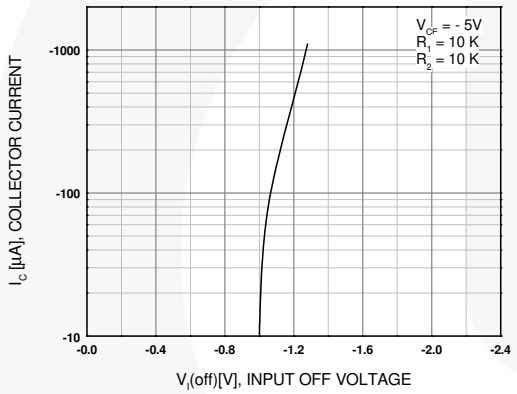

Figure 3. Input-Off Voltage

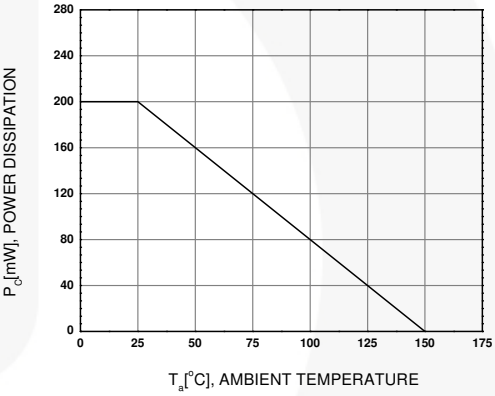

Figure 4. Power Derating

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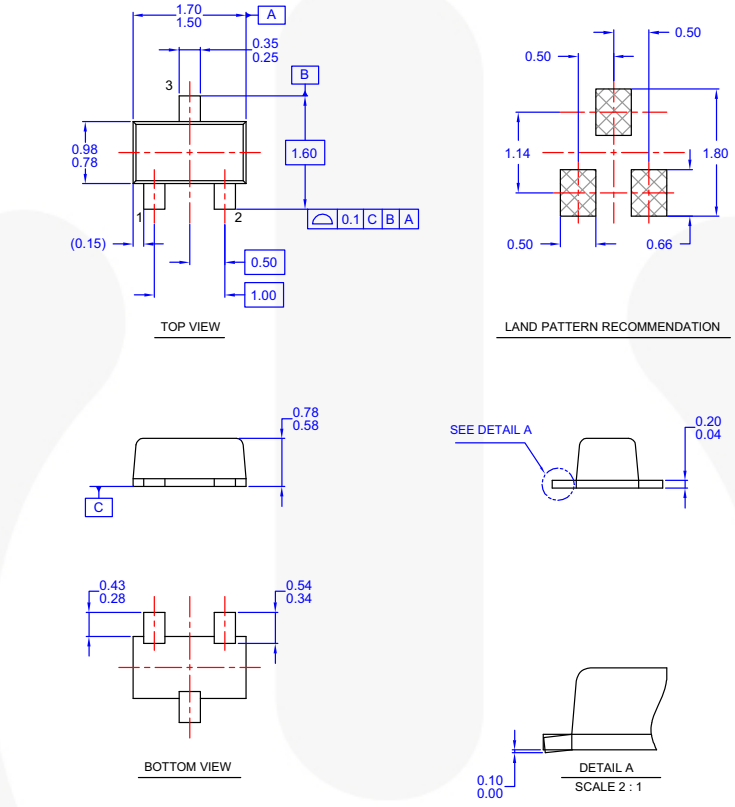
Physical Dimensions

SOT-523F



NOTES:
A) THIS PACKAGE CONFORMS TO EIAJ SC89 PACKAGING STANDARD.
B) ALL DIMENSIONS ARE IN MILLIMETERS.
C) DRAWING CONFORMS TO ASME Y14.5M-1994
D) DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.

MAD03ArevA

Figure 5. 3-LEAD, SC89, EIAJ-SC89, 0.88 MM WIDE, SOT523F (ACTIVE)

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